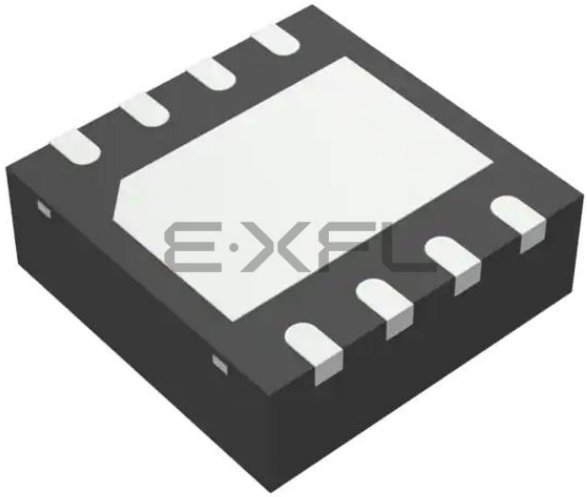

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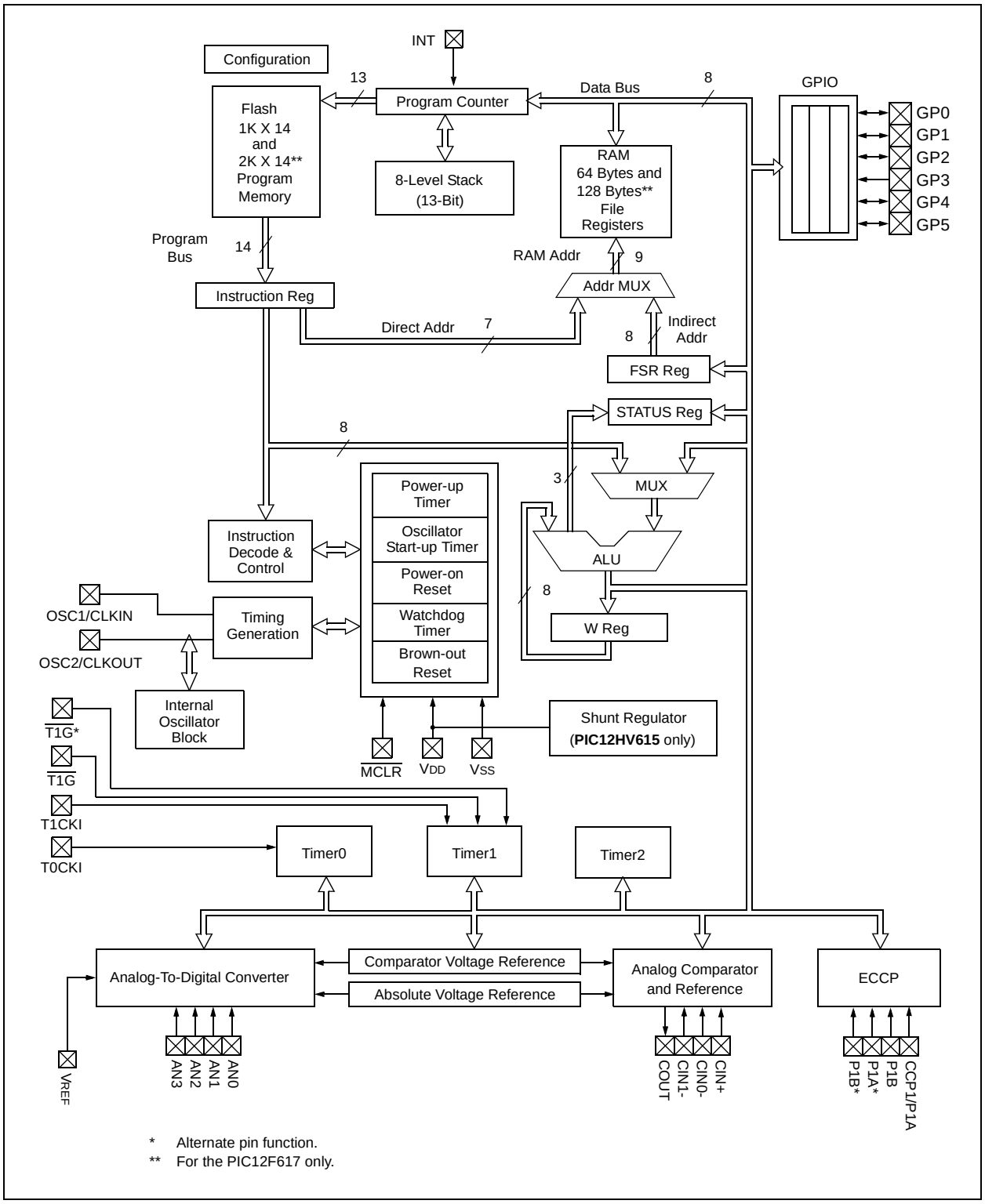
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	8-VDFN Exposed Pad
Supplier Device Package	8-DFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12hv615-e-md

FIGURE 1-2: PIC12F615/617/HV615 BLOCK DIAGRAM



* Alternate pin function.
** For the PIC12F617 only.

TABLE 1-1: PIC12F609/HV609 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
GP0/CIN+/ICSPDAT	GP0	TTL	CMOS	General purpose I/O with prog. pull-up and interrupt-on-change
	CIN+	AN	—	Comparator non-inverting input
	ICSPDAT	ST	CMOS	Serial Programming Data I/O
GP1/CIN0-/ICSPCLK	GP1	TTL	CMOS	General purpose I/O with prog. pull-up and interrupt-on-change
	CIN0-	AN	—	Comparator inverting input
	ICSPCLK	ST	—	Serial Programming Clock
GP2/T0CKI/INT/COUT	GP2	ST	CMOS	General purpose I/O with prog. pull-up and interrupt-on-change
	T0CKI	ST	—	Timer0 clock input
	INT	ST	—	External Interrupt
	COUT	—	CMOS	Comparator output
GP3/$\overline{MCLR}$/V_{PP}	GP3	TTL	—	General purpose input with interrupt-on-change
	$\overline{MCLR}$	ST	—	Master Clear w/internal pull-up
	V_{PP}	HV	—	Programming voltage
GP4/CIN1-/$\overline{T1G}$/OSC2/ CLKOUT	GP4	TTL	CMOS	General purpose I/O with prog. pull-up and interrupt-on-change
	CIN1-	AN	—	Comparator inverting input
	$\overline{T1G}$	ST	—	Timer1 gate (count enable)
	OSC2	—	XTAL	Crystal/Resonator
	CLKOUT	—	CMOS	F_{OSC}/4 output
GP5/T1CKI/OSC1/CLKIN	GP5	TTL	CMOS	General purpose I/O with prog. pull-up and interrupt-on-change
	T1CKI	ST	—	Timer1 clock input
	OSC1	XTAL	—	Crystal/Resonator
	CLKIN	ST	—	External clock input/RC oscillator connection
V_{DD}	V_{DD}	Power	—	Positive supply
V_{SS}	V_{SS}	Power	—	Ground reference

Legend: AN=Analog input or output CMOS = CMOS compatible input or output HV= High Voltage
ST=Schmitt Trigger input with CMOS levels TTL = TTL compatible input XTAL=Crystal

2.2.2.3 INTCON Register

The INTCON register is a readable and writable register, which contains the various enable and flag bits for TMR0 register overflow, GPIO change and external GP2/INT pin interrupts.

Note:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GIE	PEIE	T0IE	INTE	GPIE	T0IF	INTF	GPIF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all unmasked interrupts
0 = Disables all interrupts

bit 6 **PEIE:** Peripheral Interrupt Enable bit
1 = Enables all unmasked peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **T0IE:** Timer0 Overflow Interrupt Enable bit
1 = Enables the Timer0 interrupt
0 = Disables the Timer0 interrupt

bit 4 **INTE:** GP2/INT External Interrupt Enable bit
1 = Enables the GP2/INT external interrupt
0 = Disables the GP2/INT external interrupt

bit 3 **GPIE:** GPIO Change Interrupt Enable bit(1)
1 = Enables the GPIO change interrupt
0 = Disables the GPIO change interrupt

bit 2 **T0IF:** Timer0 Overflow Interrupt Flag bit(2)
1 = Timer0 register has overflowed (must be cleared in software)
0 = Timer0 register did not overflow

bit 1 **INTF:** GP2/INT External Interrupt Flag bit
1 = The GP2/INT external interrupt occurred (must be cleared in software)
0 = The GP2/INT external interrupt did not occur

bit 0 **GPIF:** GPIO Change Interrupt Flag bit
1 = When at least one of the GPIO <5:0> pins changed state (must be cleared in software)
0 = None of the GPIO <5:0> pins have changed state

Note 1: IOC register must also be enabled.
2: T0IF bit is set when TMR0 rolls over. TMR0 is unchanged on Reset and should be initialized before clearing T0IF bit.

2.2.2.4 PIE1 Register

The PIE1 register contains the Peripheral Interrupt Enable bits, as shown in Register 2-4.

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt.

REGISTER 2-4: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
—	ADIE(1)	CCP1IE(1)	—	CMIE	—	TMR2IE(1)	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 **ADIE:** A/D Converter (ADC) Interrupt Enable bit(1)
1 = Enables the ADC interrupt
0 = Disables the ADC interrupt

bit 5 **CCP1IE:** CCP1 Interrupt Enable bit(1)
1 = Enables the CCP1 interrupt
0 = Disables the CCP1 interrupt

bit 4 **Unimplemented:** Read as '0'

bit 3 **CMIE:** Comparator Interrupt Enable bit
1 = Enables the Comparator interrupt
0 = Disables the Comparator interrupt

bit 2 **Unimplemented:** Read as '0'

bit 1 **TMR2IE:** Timer2 to PR2 Match Interrupt Enable bit(1)
1 = Enables the Timer2 to PR2 match interrupt
0 = Disables the Timer2 to PR2 match interrupt

bit 0 **TMR1IE:** Timer1 Overflow Interrupt Enable bit
1 = Enables the Timer1 overflow interrupt
0 = Disables the Timer1 overflow interrupt

Note 1: PIC12F615/617/HV615 only. PIC12F609/HV609 unimplemented, read as '0'.

2.2.2.5 PIR1 Register

The PIR1 register contains the Peripheral Interrupt flag bits, as shown in Register 2-5.

Note:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-5: PIR1: PERIPHERAL INTERRUPT REQUEST REGISTER 1

U-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
—	ADIF(1)	CCP1IF(1)	—	CMIF	—	TMR2IF(1)	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 **ADIF:** A/D Interrupt Flag bit(1)
1 = A/D conversion complete
0 = A/D conversion has not completed or has not been started

bit 5 **CCP1IF:** CCP1 Interrupt Flag bit(1)
Capture mode:
1 = A TMR1 register capture occurred (must be cleared in software)
0 = No TMR1 register capture occurred
Compare mode:
1 = A TMR1 register compare match occurred (must be cleared in software)
0 = No TMR1 register compare match occurred
PWM mode:
Unused in this mode

bit 4 **Unimplemented:** Read as '0'

bit 3 **CMIF:** Comparator Interrupt Flag bit
1 = Comparator output has changed (must be cleared in software)
0 = Comparator output has not changed

bit 2 **Unimplemented:** Read as '0'

bit 1 **TMR2IF:** Timer2 to PR2 Match Interrupt Flag bit(1)
1 = Timer2 to PR2 match occurred (must be cleared in software)
0 = Timer2 to PR2 match has not occurred

bit 0 **TMR1IF:** Timer1 Overflow Interrupt Flag bit
1 = Timer1 register overflowed (must be cleared in software)
0 = Timer1 has not overflowed

Note 1: PIC12F615/617/HV615 only. PIC12F609/HV609 unimplemented, read as '0'.

5.0 I/O PORT

There are as many as six general purpose I/O pins available. Depending on which peripherals are enabled, some or all of the pins may not be available as general purpose I/O. In general, when a peripheral is enabled, the associated pin may not be used as a general purpose I/O pin.

5.1 GPIO and the TRISIO Registers

GPIO is a 6-bit wide port with 5 bidirectional and 1 input-only pin. The corresponding data direction register is TRISIO (Register 5-2). Setting a TRISIO bit (= 1) will make the corresponding GPIO pin an input (i.e., disable the output driver). Clearing a TRISIO bit (= 0) will make the corresponding GPIO pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). The exception is GP3, which is input only and its TRIS bit will always read as '1'. Example 5-1 shows how to initialize GPIO.

Note:	GPIO = PORTA TRISIO = TRISA

Reading the GPIO register (Register 5-1) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch. GP3 reads '0' when MCLRE = 1.

The TRISIO register controls the direction of the GPIO pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISIO register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'.

Note:	The ANSEL register must be initialized to configure an analog channel as a digital input. Pins configured as analog inputs will read '0' and cannot generate an interrupt.

EXAMPLE 5-1: INITIALIZING GPIO

```
BANKSEL  GPIO     ;
CLRF     GPIO     ;Init GPIO
BANKSEL  ANSEL    ;
CLRF     ANSEL    ;digital I/O, ADC clock
                  ;setting 'don't care'
MOVLW    0Ch      ;Set GP<3:2> as inputs
MOVWF    TRISIO    ;and set GP<5:4,1:0>
                   ;as outputs
```

REGISTER 5-1: GPIO: GPIO REGISTER

U-0	U-0	R/W-x	R/W-x	R-x	R/W-x	R/W-x	R/W-x
—	—	GP5	GP4	GP3	GP2	GP1	GP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented**: Read as '0'

bit 5-0 **GP<5:0>**: GPIO I/O Pin bit
1 = GPIO pin is > V_{IH}
0 = GPIO pin is < V_{IL}

5.2.4 PIN DESCRIPTIONS AND DIAGRAMS

Each GPIO pin is multiplexed with other functions. The pins and their combined functions are briefly described here. For specific information about individual functions such as the Comparator or the ADC, refer to the appropriate section in this data sheet.

5.2.4.1 GP0/AN0(1)/CIN+/P1B(1)/ICSPDAT

Figure 5-1 shows the diagram for this pin. The GP0 pin is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC(1)
- an analog non-inverting input to the comparator
- a PWM output(1)
- In-Circuit Serial Programming data

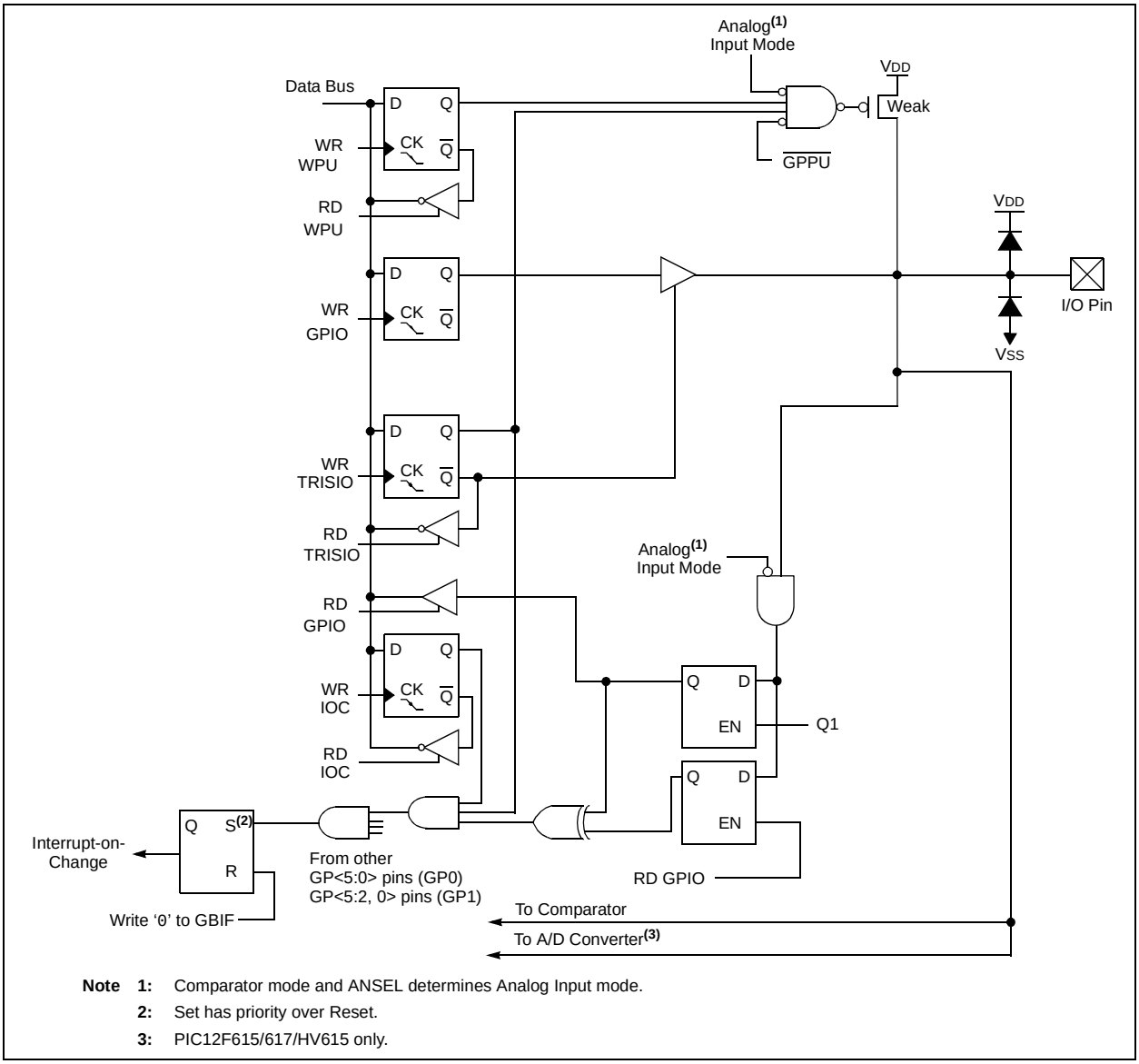
5.2.4.2 GP1/AN1(1)/CIN0-/VREF(1)/ICSPCLK

Figure 5-1 shows the diagram for this pin. The GP1 pin is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC(1)
- an analog inverting input to the comparator
- a voltage reference input for the ADC(1)
- In-Circuit Serial Programming clock

Note 1: PIC12F615/617/HV615 only.

FIGURE 5-1: BLOCK DIAGRAM OF GP<1:0>



Note 1: Comparator mode and ANSEL determines Analog Input mode.
2: Set has priority over Reset.
3: PIC12F615/617/HV615 only.

NOTES:

7.0 TIMER1 MODULE WITH GATE CONTROL

The Timer1 module is a 16-bit timer/counter with the following features:

- 16-bit timer/counter register pair (TMR1H:TMR1L)
- Programmable internal or external clock source
- 3-bit prescaler
- Optional LP oscillator
- Synchronous or asynchronous operation
- Timer1 gate (count enable) via comparator or $\overline{T1G}$ pin
- Interrupt on overflow
- Wake-up on overflow (external clock, Asynchronous mode only)
- Time base for the Capture/Compare function
- Special Event Trigger (with ECCP)
- Comparator output synchronization to Timer1 clock

Figure 7-1 is a block diagram of the Timer1 module.

7.1 Timer1 Operation

The Timer1 module is a 16-bit incrementing counter which is accessed through the TMR1H:TMR1L register pair. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer. When used with an external clock source, the module can be used as either a timer or counter.

7.2 Clock Source Selection

The TMR1CS bit of the T1CON register is used to select the clock source. When TMR1CS = 0, the clock source is FOSC/4. When TMR1CS = 1, the clock source is supplied externally.

Clock Source	TMR1CS	T1ACS
FOSC/4	0	0
FOSC	0	1
T1CKI pin	1	x

9.2 Analog Input Connection Considerations

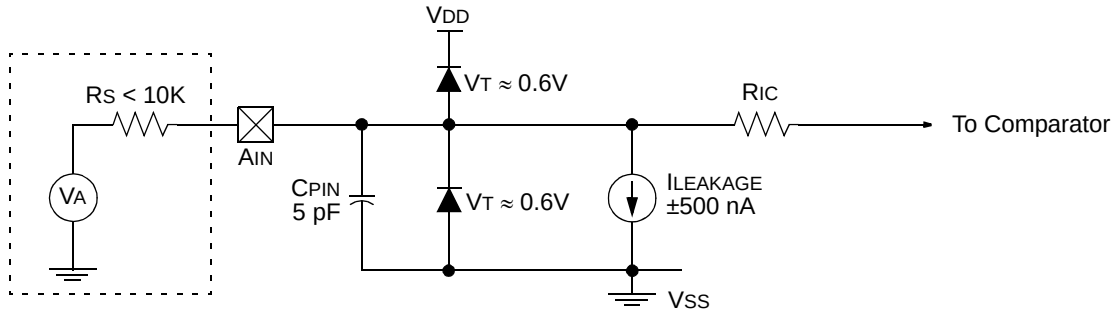
A simplified circuit for an analog input is shown in Figure 9-3. Since the analog input pins share their connection with a digital input, they have reverse biased ESD protection diodes to VDD and VSS. The analog input, therefore, must be between VSS and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur.

A maximum source impedance of 10 kΩ is recommended for the analog sources. Also, any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current to minimize inaccuracies introduced.

Note 1: When reading a GPIO register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert as an analog input, according to the input specification.

2: Analog levels on any pin defined as a digital input, may cause the input buffer to consume more current than is specified.

FIGURE 9-3: ANALOG INPUT MODEL



Legend: CPIN = Input Capacitance
ILEAKAGE = Leakage Current at the pin due to various junctions
RIC = Interconnect Resistance
RS = Source Impedance
VA = Analog Voltage
VT = Threshold Voltage

12.3.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in Reset until V_{DD} has reached a high enough level for proper operation. To take advantage of the POR, simply connect the $\overline{MCLR}$ pin through a resistor to V_{DD}. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for V_{DD} is required. See **Section 16.0 "Electrical Specifications"** for details. If the BOR is enabled, the maximum rise time specification does not apply. The BOR circuitry will keep the device in Reset until V_{DD} reaches V_{BOR} (see **Section 12.3.4 "Brown-out Reset (BOR)"**).

Note:	The POR circuit does not produce an internal Reset when V_{DD} declines. To re-enable the POR, V_{DD} must reach Vss for a minimum of 100 µs.

When the device starts normal operation (exits the Reset condition), device operating parameters (i.e., voltage, frequency, temperature, etc.) must be met to ensure proper operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

For additional information, refer to Application Note AN607, *"Power-up Trouble Shooting"* (DS00607).

12.3.2 $\overline{MCLR}$

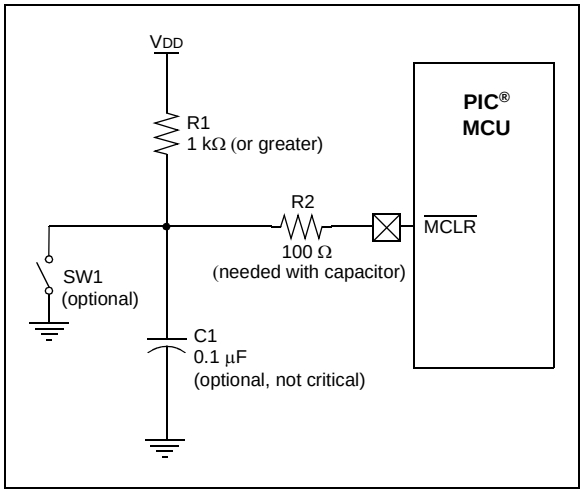
PIC12F609/615/617/12HV609/615 has a noise filter in the $\overline{MCLR}$ Reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive $\overline{MCLR}$ pin low.

Voltages applied to the $\overline{MCLR}$ pin that exceed its specification can result in both $\overline{MCLR}$ Resets and excessive current beyond the device specification during the ESD event. For this reason, Microchip recommends that the $\overline{MCLR}$ pin no longer be tied directly to V_{DD}. The use of an RC network, as shown in Figure 12-2, is suggested.

An internal $\overline{MCLR}$ option is enabled by clearing the MCLRE bit in the Configuration Word register. When MCLRE = 0, the Reset signal to the chip is generated internally. When the MCLRE = 1, the GP3/$\overline{MCLR}$ pin becomes an external Reset input. In this mode, the GP3/$\overline{MCLR}$ pin has a weak pull-up to V_{DD}.

FIGURE 12-2: RECOMMENDED $\overline{MCLR}$ CIRCUIT



12.3.3 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 64 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates from an internal RC oscillator. For more information, see **Section 4.4 "Internal Clock Modes"**. The chip is kept in Reset as long as PWRT is active. The PWRT delay allows the V_{DD} to rise to an acceptable level. A Configuration bit, $\overline{PWRTE}$, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should be enabled when Brown-out Reset is enabled, although it is not required.

The Power-up Timer delay will vary from chip-to-chip due to:

- V_{DD} variation
- Temperature variation
- Process variation

See DC parameters for details (**Section 16.0 "Electrical Specifications"**).

Note:	Voltage spikes below V_{SS} at the $\overline{MCLR}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{MCLR}$ pin, rather than pulling this pin directly to V_{SS}.

DECFSZ **Decrement f, Skip if 0**

Syntax: [*label*] DECFSZ f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) - 1 → (destination);
skip if result = 0

Status Affected: None

Description: The contents of register 'f' are decremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.
If the result is '1', the next instruction is executed. If the result is '0', then a NOP is executed instead, making it a two-cycle instruction.

GOTO **Unconditional Branch**

Syntax: [*label*] GOTO k

Operands: $0 \le k \le 2047$

Operation: k → PC<10:0>
PCLATH<4:3> → PC<12:11>

Status Affected: None

Description: GOTO is an unconditional branch. The eleven-bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.

INCF **Increment f**

Syntax: [*label*] INCF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) + 1 → (destination)

Status Affected: Z

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

INCFSZ **Increment f, Skip if 0**

Syntax: [*label*] INCFSZ f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) + 1 → (destination),
skip if result = 0

Status Affected: None

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.
If the result is '1', the next instruction is executed. If the result is '0', a NOP is executed instead, making it a two-cycle instruction.

IORLW **Inclusive OR literal with W**

Syntax: [*label*] IORLW k

Operands: $0 \le k \le 255$

Operation: (W) .OR. k → (W)

Status Affected: Z

Description: The contents of the W register are OR'ed with the eight-bit literal 'k'. The result is placed in the W register.

IORWF **Inclusive OR W with f**

Syntax: [*label*] IORWF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (W) .OR. (f) → (destination)

Status Affected: Z

Description: Inclusive OR the W register with register 'f'. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

16.0 ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings(†)

Ambient temperature under bias ..... -40° to +125°C
Storage temperature ..... -65°C to +150°C
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to +6.5V
Voltage on $\overline{MCLR}$ with respect to Vss ..... -0.3V to +13.5V
Voltage on all other pins with respect to V_{SS} ..... -0.3V to (V_{DD} + 0.3V)
Total power dissipation(1) ..... 800 mW
Maximum current out of V_{SS} pin ..... 95 mA
Maximum current into V_{DD} pin ..... 95 mA
Input clamp current, I_{IK} (V_I < 0 or V_I > V_{DD}) ..... ± 20 mA
Output clamp current, I_{OK} (Vo < 0 or Vo >V_{DD}) ..... ± 20 mA
Maximum output current sunk by any I/O pin ..... 25 mA
Maximum output current sourced by any I/O pin ..... 25 mA
Maximum current sunk by GPIO ..... 90 mA
Maximum current sourced GPIO ..... 90 mA

Note 1: Power dissipation is calculated as follows: $P_{DIS} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum(Vol \times I_{OL})$.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

16.2 DC Characteristics: PIC12F609/615/617-I (Industrial) PIC12F609/615/617-E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D010	**Supply Current (IDD)(1, 2)** PIC12F609/615/617	—	13	25	µA	2.0	FOSC = 32 kHz LP Oscillator mode
		—	19	29	µA	3.0	
		—	32	51	µA	5.0	
D011*		—	135	225	µA	2.0	FOSC = 1 MHz XT Oscillator mode
		—	185	285	µA	3.0	
		—	300	405	µA	5.0	
D012		—	240	360	µA	2.0	FOSC = 4 MHz XT Oscillator mode
		—	360	505	µA	3.0	
		—	0.66	1.0	mA	5.0	
D013*		—	75	110	µA	2.0	FOSC = 1 MHz EC Oscillator mode
		—	155	255	µA	3.0	
		—	345	530	µA	5.0	
D014		—	185	255	µA	2.0	FOSC = 4 MHz EC Oscillator mode
		—	325	475	µA	3.0	
		—	0.665	1.0	mA	5.0	
D016*		—	245	340	µA	2.0	FOSC = 4 MHz INTOSC mode
		—	360	485	µA	3.0	
		—	0.620	0.845	mA	5.0	
D017		—	395	550	µA	2.0	FOSC = 8 MHz INTOSC mode
		—	0.620	0.850	mA	3.0	
		—	1.2	1.6	mA	5.0	
D018		—	175	235	µA	2.0	FOSC = 4 MHz EXTRC mode(3)
		—	285	390	µA	3.0	
		—	530	750	µA	5.0	
D019		—	2.2	3.1	mA	4.5	FOSC = 20 MHz HS Oscillator mode
		—	2.8	3.35	mA	5.0	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\overline{MCLR}$ = VDD; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be extended by the formula IR = VDD/2REXT (mA) with REXT in KOhms (KΩ).

16.5 DC Characteristics: PIC12F609/615/617 - E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D020E	**Power-down Base Current (IPD)(2)** PIC12F609/615/617	—	0.05	4.0	µA	2.0	WDT, BOR, Comparator, VREF and T1OSC disabled
		—	0.15	5.0	µA	3.0	
		—	0.35	8.5	µA	5.0	
D021E		—	0.5	5.0	µA	2.0	WDT Current(1)
		—	2.5	8.0	µA	3.0	
		—	9.5	19	µA	5.0	
D022E		—	5.0	15	µA	3.0	BOR Current(1)
		—	6.0	19	µA	5.0	
D023E		—	50	70	µA	2.0	Comparator Current(1), single comparator enabled
		—	55	75	µA	3.0	
		—	60	80	µA	5.0	
D024E		—	30	40	µA	2.0	CVREF Current(1) (high range)
		—	45	60	µA	3.0	
		—	75	105	µA	5.0	
D025E*		—	39	50	µA	2.0	CVREF Current(1) (low range)
		—	59	80	µA	3.0	
		—	98	130	µA	5.0	
D026E		—	5.5	16	µA	2.0	T1OSC Current(1), 32.768 kHz
		—	7.0	18	µA	3.0	
		—	8.5	22	µA	5.0	
D027E		—	0.2	6.5	µA	3.0	A/D Current(1), no conversion in progress
		—	0.36	10	µA	5.0	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral current is the sum of the base IDD or IPD and the additional current consumed when this peripheral is enabled. The peripheral Δ current can be determined by subtracting the base IDD or IPD current from this limit. Max values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD.

TABLE 16-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET PARAMETERS

Standard Operating Conditions (unless otherwise stated) Operating Temperature -40°C ≤ TA ≤ +125°C							
Param No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
30	TMCL	$\overline{\text{MCLR}}$ Pulse Width (low)	2 5	— —	— —	μs μs	VDD = 5V, -40°C to +85°C VDD = 5V, -40°C to +125°C
31*	TWDT	Watchdog Timer Time-out Period (No Prescaler)	10 10	20 20	30 35	ms ms	VDD = 5V, -40°C to +85°C VDD = 5V, -40°C to +125°C
32	TOST	Oscillation Start-up Timer Period(1, 2)	—	1024	—	TOSC	**(NOTE 3)**
33*	TPWRT	Power-up Timer Period	40	65	140	ms	
34*	TIOZ	I/O High-impedance from $\overline{\text{MCLR}}$ Low or Watchdog Timer Reset	—	—	2.0	μs	
35	VBOR	Brown-out Reset Voltage	2.0	2.15	2.3	V	**(NOTE 4)**
36*	VHYST	Brown-out Reset Hysteresis	—	100	—	mV	
37*	TBOR	Brown-out Reset Minimum Detection Period	100	—	—	μs	VDD ≤ VBOR

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min" values with an external clock applied to the OSC1 pin. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: By design.

3: Period of the slower clock.

4: To ensure these voltage tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 μF and 0.01 μF values in parallel are recommended.

TABLE 16-11: PIC12F615/617/HV615 A/D CONVERTER (ADC) CHARACTERISTICS:

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
AD01	NR	Resolution	—	—	10 bits	bit	
AD02	EIL	Integral Error	—	—	±1	LSb	VREF = 5.12V(5)
AD03	EDL	Differential Error	—	—	±1	LSb	No missing codes to 10 bits VREF = 5.12V(5)
AD04	EOFF	Offset Error	—	+1.5	+2.0	LSb	VREF = 5.12V(5)
AD07	EGN	Gain Error	—	—	±1	LSb	VREF = 5.12V(5)
AD06 AD06A	VREF	Reference Voltage(3)	2.2 2.5	—	— VDD	V	 Absolute minimum to ensure 1 LSb accuracy
AD07	VAIN	Full-Scale Range	VSS	—	VREF	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	
AD09*	IREF	VREF Input Current(3)	10	—	1000	μA	During VAIN acquisition. Based on differential of VHOLD to VAIN.
			—	—	50	μA	During A/D conversion cycle.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error includes integral, differential, offset and gain errors.

2: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

3: ADC VREF is from external VREF or VDD pin, whichever is selected as reference input.

4: When ADC is off, it will not consume any current other than leakage current. The power-down current specification includes any such leakage from the ADC module.

5: VREF = 5V for PIC12HV615.

16.12 High Temperature Operation

This section outlines the specifications for the PIC12F615 device operating in a temperature range between -40°C and 150°C.(4) The specifications between -40°C and 150°C(4) are identical to those shown in DS41288 and DS80329.

Note 1: Writes are **not allowed** for Flash Program Memory above 125°C.

2: All AC timing specifications are increased by 30%. This derating factor will include parameters such as TPWRT.

3: The temperature range indicator in the part number is "H" for -40°C to 150°C.(4)

Example: PIC12F615T-H/ST indicates the device is shipped in a TAPE and reel configuration, in the MSOP package, and is rated for operation from -40°C to 150°C.(4)

4: AEC-Q100 reliability testing for devices intended to operate at 150°C is 1,000 hours. Any design in which the total operating time from 125°C to 150°C will be greater than 1,000 hours is not warranted without prior written approval from Microchip Technology Inc.

TABLE 16-13: ABSOLUTE MAXIMUM RATINGS

Parameter	Source/Sink	Value	Units
Max. Current: VDD	Source	20	mA
Max. Current: VSS	Sink	50	mA
Max. Current: PIN	Source	5	mA
Max. Current: PIN	Sink	10	mA
Pin Current: at VOH	Source	3	mA
Pin Current: at VOL	Sink	8.5	mA
Port Current: GPIO	Source	20	mA
Port Current: GPIO	Sink	50	mA
Maximum Junction Temperature		155	°C

Note: Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

FIGURE 17-52: COMPARATOR RESPONSE TIME (FALLING EDGE)

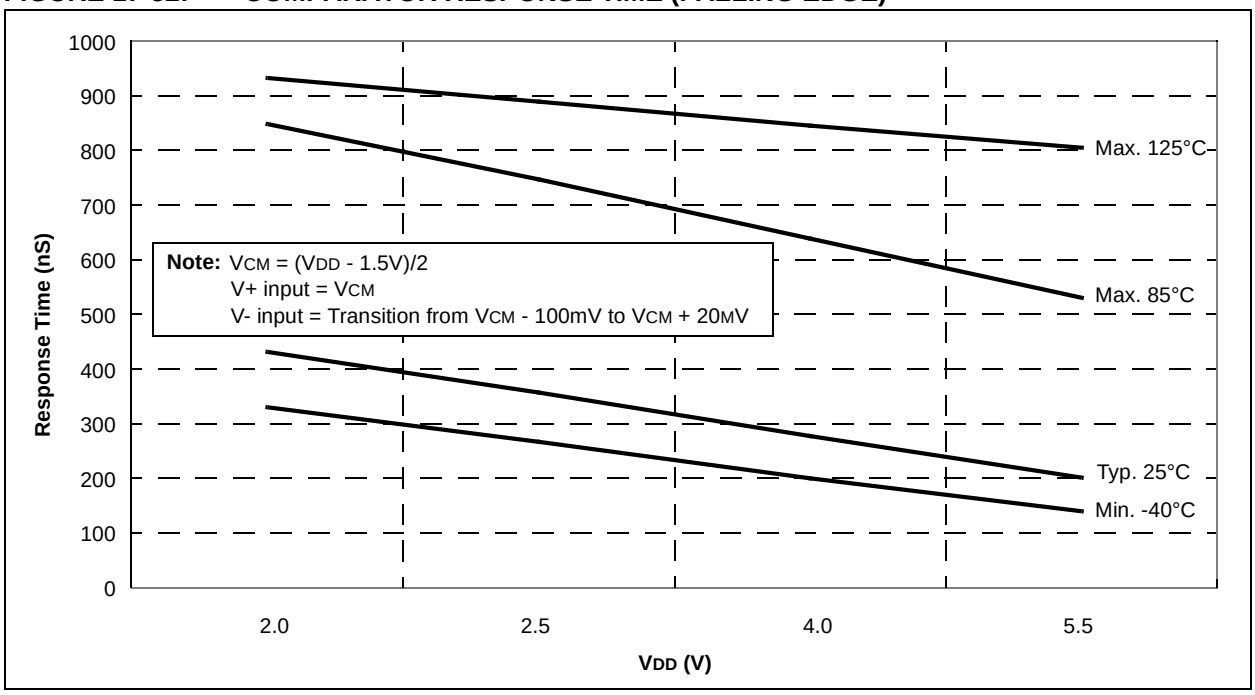


FIGURE 17-53: WDT TIME-OUT PERIOD vs. VDD OVER TEMPERATURE